

*Preliminary Specifications Subject to Change without Notice*

## DESCRIPTION

JW<sup>®</sup>7726BL is a synchronous rectifier controller, used for the secondary side rectification of isolation topologies, such as Active Clamp Flyback and CCM/QR/DCM Flyback. By driving an external MOSFET, JW7726BL is able to significantly improve the efficiency comparing with the conventional diode rectifier.

When JW7726BL senses  $V_{ds}$  of MOSFET less than  $-140mV$ , it turns on the MOSFET. Once the  $V_{ds}$  is greater than  $-6mV$ , JW7726BL turns off the MOSFET.

JW7726BL supports multiple operation modes, such as DCM, CrCM, CCM and Quasi-Resonant. By implementing the Joulwatt proprietary technology, JW7726BL is able to handle CCM operation.

JW7726BL is available in SOT23-6 package.

Company's Logo is Protected, "JW" and "JOULWATT" are Registered Trademarks of JoulWatt technology Inc.

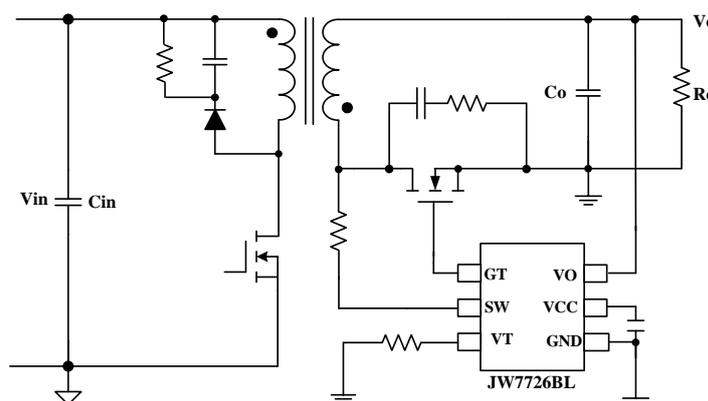
## FEATURES

- Supports Active Clamp Flyback, DCM, Quasi-Resonant, and CCM Flyback
- Support High-side and Low-side Rectification
- Output Voltage Directly Supply VCC
- Low Quiescent Current
- Fast Driver Capability for CCM Operation
- SOT23-6 Package

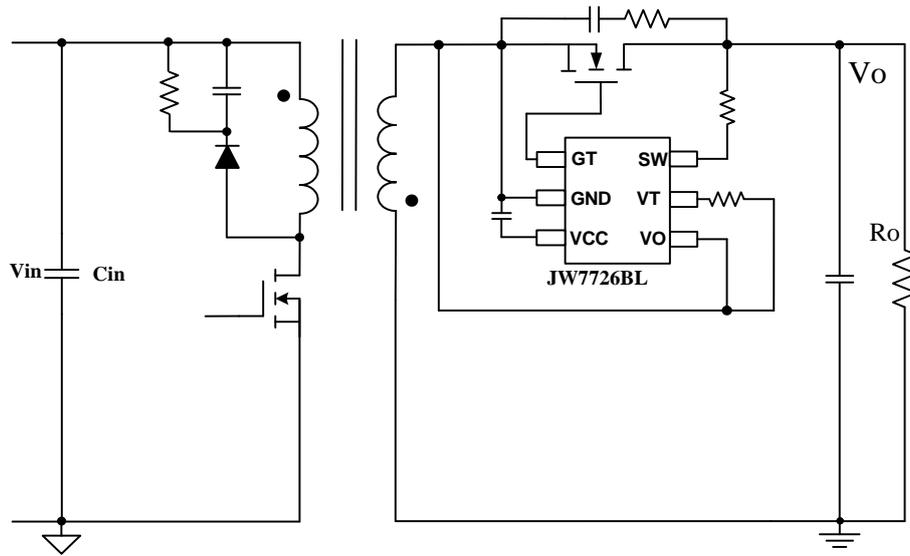
## APPLICATIONS

- Active Clamp Flyback and Flyback Converters
- Adaptor
- LCD and PDP TV

## TYPICAL APPLICATION



**JW7726BL Typical Application for Low-side.**

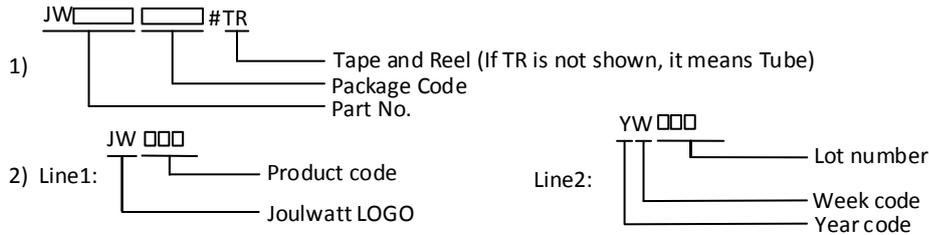


JW7726BL Typical Application for High-side.

**ORDER INFORMATION**

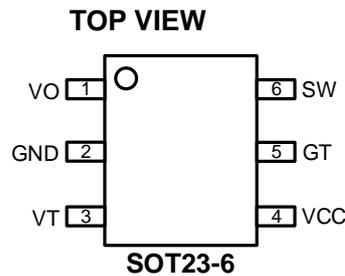
DEVICE <sup>1)</sup>	PACKAGE	TOP MARKING <sup>2)</sup>	ENVIRONMENTAL <sup>3)</sup>
JW7726BLSOTB#TR	SOT23-6	JWJB □ YW □ □ □	Green

**Notes:**



3) All Joulwatt products are packaged with Pb-free and Halogen-free materials and compliant to RoHS standards.

**PIN CONFIGURATION**



**ABSOLUTE MAXIMUM RATING<sup>1)</sup>**

SW PIN .....	-1 to 150V
VO PIN .....	-0.3 to 28V
VCC, GT PIN.....	-0.3 to 9V
VT PIN.....	-0.3 to 7V
Junction Temperature <sup>2) 3)</sup> .....	150°C
Lead Temperature .....	260°C
Storage Temperature.....	-65°C to 150°C
Continuous Power Dissipation( $T_A=+25^\circ\text{C}$ ) <sup>4)</sup> SOT23-6.....	0.625W
ESD Susceptibility (Human Body Model) .....	2kV

**RECOMMENDED OPERATING CONDITIONS**

SW Pin.....	4.7V to 130V
VO Pin.....	4.7V to 25V
VCC, GT PIN.....	4V to 8.5V
Operation Junction Temperature(T <sub>J</sub> ).....	-40°C to 125°C

**THERMAL PERFORMANCE<sup>5)</sup>**

	$\theta_{JA}$	$\theta_{JC}$
SOT23-6.....	200	130°C/W

**Notes :**

- 1) Exceeding these ratings may damage the device. These stress rating do not imply function operation of the device at any other conditions beyond those indicated under RECOMMENDED OPERATING CONDITIONS.
- 2) Continuous operation over the specified absolute maximum operating junction temperature may damage the device.
- 3) The device is not guaranteed to function outside of its operating conditions.
- 4) The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_D(MAX) = (T_J(MAX) - T_A) / \theta_{JA}$ .
- 5) Measured on JESD51-7, 4-layer PCB.

**ELECTRICAL CHARACTERISTICS**

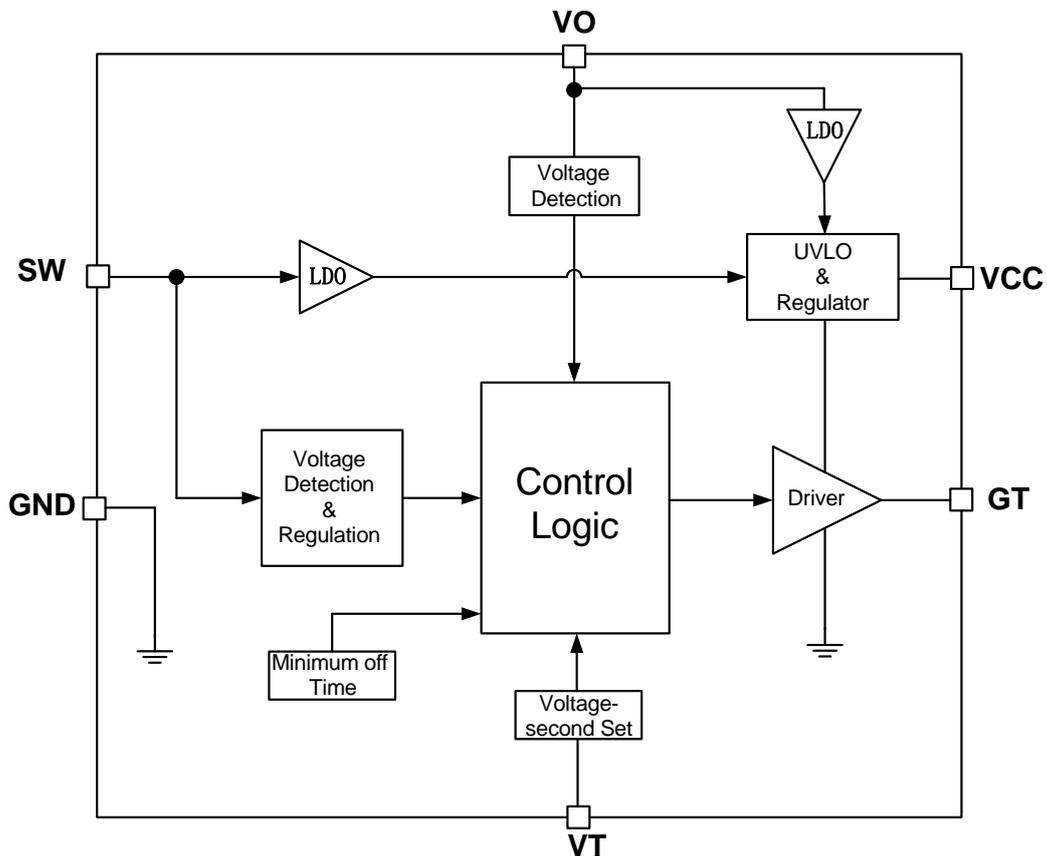
<i>TA = 25°C, unless otherwise stated</i>						
<b>Item</b>	<b>Symbol</b>	<b>Condition</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	<b>Units</b>
<i>VCC Section</i>						
VCC Voltage	VCC	SW=40V, VCC=2.2uF	7.4	7.9	8.4	V
VCC Startup Voltage	V <sub>CC_Startup</sub>		4.2	4.5	4.8	V
VCC UVLO	V <sub>CC_UVLO</sub>		3.7	3.95	4.2	V
Operation Current (GT On)	I <sub>VCC</sub>	GT=5nF, VCC=2.2uF	0.7	0.9	1.1	mA
Quiescent Current	I <sub>q</sub>	VCC=4.5V, VCC=2.2uF	100	120	140	uA
<i>Gate Section</i>						
Gate Turn on Threshold	V <sub>MOS_ON</sub>		-170	-140	-110	mV
Gate Turn off Threshold	V <sub>MOS_OFF</sub>		-12	-6	0	mV
Gate Turn on Voltage	V <sub>GT</sub>	SW=32V, VCC=2.2uF		V <sub>CC</sub>		V
Maximum Gate Pull Up Current <sup>6)</sup>	I <sub>GU</sub>			0.6		A
Maximum Gate Pull Down Current <sup>6)</sup>	I <sub>GD</sub>			4.0		A
Gate Minimum on Time	T <sub>MIN_ON</sub>		970	1070	1170	nS
Turn-on Total Delay <sup>6)</sup>	T <sub>DON</sub>	C <sub>LOAD</sub> =4.7nF		50		nS
Turn-off Total Delay <sup>6)</sup>	T <sub>DOF</sub>	C <sub>LOAD</sub> =4.7nF		20		nS
<i>SW and VO Section</i>						
Volt-second Threshold <sup>6)</sup>	TH_V*us	VT=100K $\Omega$ , Volt-second increasing	20.9	24	27.1	V*us
Volt-second Threshold Hysteresis <sup>6)</sup>	TH_hys	VT=100K $\Omega$ , Volt-second increasing	24%	25%	26%	
VCC Charge Current	I <sub>SW_CHG</sub>	SW=40V, VCC=6V	75	95		mA
SW Regulation Voltage	V <sub>MOS_REG</sub>		-50	-38	-26	mV
SW Control Voltage MAX	V <sub>MOS_REG_MAX</sub>		-190	-165	-140	mV
VO Enable Charge Voltage	V <sub>O_EN</sub>	VCC=4V, SW=0V, rising	4.5	4.65	4.8	V
VO Disable Charge Voltage	V <sub>O_DIS</sub>	VCC=4V, SW=0V, falling	4.4	4.55	4.7	V
VO Charge Current	I <sub>VO_CHG</sub>	SW=0V, VCC=6V, VO=12V	28	40	52	mA

6) Guaranteed by design. Not tested in production.

PIN DESCRIPTION

Part No. SOT23-6	Name	Description
1	VO	Output voltage sensing and charging to VCC.
2	GND	Ground.
3	VT	Set the voltage-second product.
4	VCC	Power supply. Bypass a capacitor between VCC and GND.
5	GT	Drive the external MOSFET.
6	SW	External power MOSFET drain voltage sensing. Charging to VCC.

BLOCK DIAGRAM



## FUNCTIONAL DESCRIPTION

### Operation

JW7726BL is a synchronous rectifier controller which combined with external MOSFET can replace the Schottky Barrier Diode. It supports all operations, such as DCM, CrCM, (Quasi-Resonant) and CCM when adopted in Active Clamp Flyback and Flyback converters.

### Startup

During the startup period, when the VCC is charged up by the two internal LDOs connected to SW and VO pin respectively.

When VO is lower than 4.55V (falling), JW7726BL can power itself through the internal LDO connected to SW pin during the SR turn-off period, which means primary the primary side MOSFET is turned on and SW presents a positive voltage. A capacitor between VCC and GND is required to store the energy and supply to IC during the SR turn-on period.

When VO is above 4.65V (rising), the VO pin charges VCC pin.

Once the VCC voltage exceeds  $V_{CC\_Startup}$ , the JW7726BL exits the UVLO. If VCC is lower than  $V_{CC\_UVLO}$ , the external MOSFET is turned off. The current flows through body diode before the VCC reaches to the startup voltage  $V_{cc\_startup}$ .

### Under-Voltage Lockout (UVLO)

When the VCC is below UVLO threshold, the external MOSFET is turned off and pulled low internally. Once the VCC exceeds the startup voltage  $V_{cc\_startup}$ , the parts is activated again.

### Turn On Phase

There are two conditions for the JW7726BL to turn on the SR, i.e.  $V_{sw}$ , voltage-second value on SW pin when primary side switch is on, and the turn on phase is shown in Fig. 1.

1)  $V_{sw}$ : when the synchronous MOEFET is conducting, current flows through the body diode of MOSFET, which generates a negative voltage  $V_{SW}$  across it. When  $V_{SW}$  is lower than  $V_{MOS\_ON}$ , the part will pull the gate high to turn on the synchronous MOSFET after turn on delay time  $T_{DON}$  if the other condition is met.

2) Volt-second of SW: in DCM and QR operation, there are parasitic oscillations. In some applications, the drain resonant voltage may fall below the SR turn on threshold, especially for the first couple rings. SR could be falsely turned on, which may cause shoot through issue and result in high power loss. The volt-second value of SW pin can be used to distinguish the parasitic ring from normal primary side switch on. The threshold can be set by the resistance at VT pin. The curve is shown in Fig. 2.

In application, as the output load( $I_o$ ) of converter increases, the volt-second value( $S1$ ) of SW pin also increases. When the volt-second value( $S1$ ) of SW pin is greater than the high threshold and gate turns on, the high threshold becomes to low threshold. As the output load decreasing, when the gate turns off and the MOSFET bodydiode conduction time is no shorter than  $T_{on\_min.}$ , the low threshold becomes to the high threshold. When the  $R_{vt}$  is more than  $250k\Omega$ , the high threshold is fixed and the low threshold increases with the increasing of  $R_{vt}$ . The low threshold is fixed and equal to the high threshold when the  $R_{vt}$  is more than  $330k\Omega$ . The voltage-second hysteresis is shown in Fig. 2 and Fig. 3.

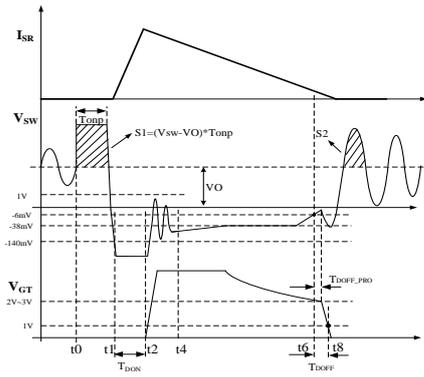


Fig. 1 Turn on delay and turn off delay

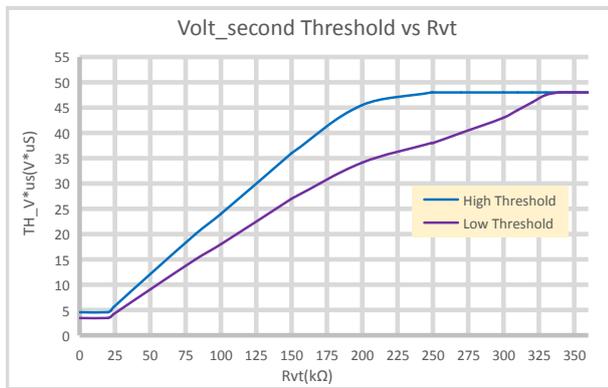


Fig. 2 Volt-second value vs. VT resistance

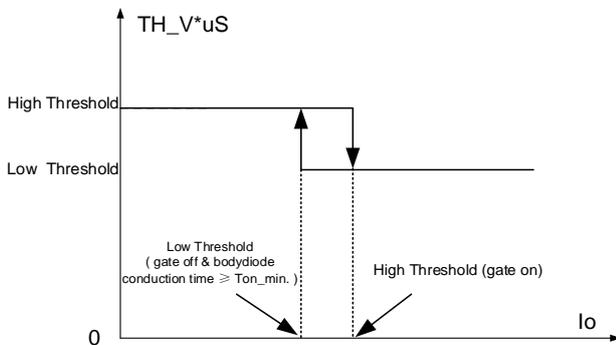


Fig. 3 Volt-second value with hysteresis

**Minimum On Time (MOT)**

When the synchronous MOSFET is turn on, there is a minimum on time for the SR. The  $V_{sw}$  voltage may have a parasitic ring when the synchronous MOSFET turns on. So, a minimum on time (MOT) is very important to avoid the MOSFET turn off threshold is false triggered.

**Conducting Phase**

When the synchronous MOSFET is turned on, the drain source voltage  $V_{sw}$  it is determined by its on resistance and the current through it. The part adjusts the gate voltage and regulates the  $V_{sw}$  to the internal threshold (typical -38mV) after the synchronous MOSFET turn on. When the  $V_{sw}$  is lower than -38mV, the gate keeps its maximum voltage. And the synchronous MOSFET is fully on.

The  $V_{sw}$  rises when the current follow through the MOSFET decreases. The gate voltage will be decreased to increase its on resistance and regulate the  $V_{sw}$  around -38mV.

It should be noted that the typical regulation threshold (-38mV) during MOSFET on time is not fixed, it can be internally changed to ensure the proper operation under CCM mode.

**Turn Off Phase**

After synchronous MOSFET conducting, once the voltage  $V_{sw}$  touches the MOSFET turn off threshold (-6mV), the gate is pulled to low after a turn off delay time  $T_{DOFF}$ . A 330nS blanking time is necessary to avoid error trigger. The banking time is reset once  $V_{sw}$  rises above 2.5V.

**Output Voltage Detection**

The JW7726BL has output voltage detection function via  $V_O$  pin.  $V_{CC}$  is charged from  $V_O$  pin when  $V_O$  is higher than 4.65V to save power loss caused by the LDO when charging from  $SW$  pin to  $V_{CC}$  pin. When  $V_O$  drops below 4.55V, the JW7726BL is powered from  $SW$  pin.

PACKAGE OUTLINE

SOT23-6	UNIT: mm
---------	----------

SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	1.05	1.15	1.25
A1	0	0.05	0.15
A2	0.95	1.10	1.20
b	0.20	0.40	0.60
c	0.05	—	0.21
D	2.72	2.92	3.12
E	2.60	2.80	3.00
E1	1.40	1.60	1.80
e	0.95 (BSC)		
L	0.30	0.45	0.60
θ	0°	—	8°

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPAE**

Sprocket Holes

Sprocket Quadrants

Package Type	Pin1 Quadrant
SOT23-6	3

## IMPORTANT NOTICE

- Joulwatt Technology Inc. reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein.
- Any unauthorized redistribution or copy of this document for any purpose is strictly forbidden.
- Joulwatt Technology Inc. does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.

*Copyright © 2020 JW7726BL Incorporated.*

*All rights are reserved by Joulwatt Technology Inc.*